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Single-pole single-throw analog switch Rev. 1 — 16 September 2013

Product data sheet

1. General description

The 74HC1G66-Q100; 74HCT1G66-Q100 is a single-pole, single-throw analog switch with two input/output terminals (nY and nZ) and a digital enable input (nE). When nE is LOW, the analog switch is turned off. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

- Automotive product qualification in accordance with AEC-Q100 (Grade 1) Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- Wide supply voltage range from 2.0 V to 10.0 V for the 74HC1G66-Q100
- Very low ON resistance:
 - 45 Ω (typ.) at V_{CC} = 4.5 V
 - 30 Ω (typ.) at V_{CC} = 6.0 V
 - 25 Ω (typ.) at V_{CC} = 9.0 V
- High noise immunity
- Low power dissipation
- Multiple package options
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pf, R = 0 Ω)

Ordering information 3.

Table 1. **Ordering information**

Type number	Package							
	Temperature range	Name	Description	Version				
74HC1G66GW-Q100	–40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package;	SOT353-1				
74HCT1G66GW-Q100			5 leads; body width 1.25 mm					
74HC1G66GV-Q100	–40 °C to +125 °C	SC-74A	plastic surface-mounted package; 5 leads	SOT753				
74HCT1G66GV-Q100								

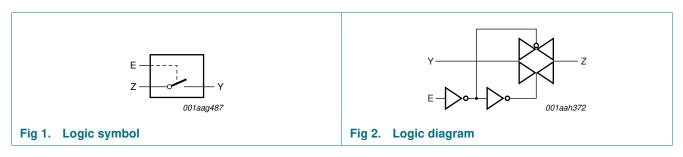


Single-pole single-throw analog switch

Marking 4.

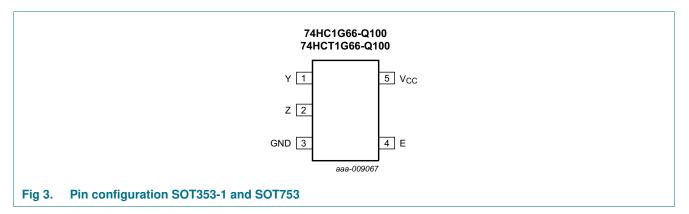
Table 2. Marking codes	
Type number	Marking
74HC1G66GW-Q100	HL
74HCT1G66GW-Q100	TL
74HC1G66GV-Q100	H66
74HCT1G66GV-Q100	T66

Functional diagram 5.



Pinning information 6.

6.1 Pinning



6.2 Pin description

Table 3.	Pin description	
Symbol	Pin	Description
Υ	1	independent input or output
Z	2	independent input or output
GND	3	ground (0 V)
E	4	enable input (active HIGH)
V _{CC}	5	supply voltage

Single-pole single-throw analog switch

7. Functional description

ľ	Table 4.	Function	table ^[1]

Input E	Switch
L	OFF
Н	ON

[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+11.0	V
I _{IK}	input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I}~>V_{\rm CC}$ + 0.5 V	<u>[1]</u> -	±20	mA
I _{SK}	switch clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC}$ + 0.5 V	<u>[1]</u> -	±20	mA
I _{SW}	switch current	V_{SW} > –0.5 V or V_{SW} < V_{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] -	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 and SC-74A packages: above 87.5 °C the value of Ptot derates linearly with 4.0 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).[1]

Symbol	Parameter	Conditions	74HC1G66-Q100			74H0	Q100	Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	10.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V_{CC}	0	-	V_{CC}	V
V _{SW}	switch voltage		0	-	V_{CC}	0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V
		$V_{CC} = 10.0 V$	-	-	35	-	-	-	ns/V

[1] To avoid drawing V_{CC} current from pin Z, when switch current flows in pin Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into pin Z, no V_{CC} current flows from terminal Y. In this case, the voltage drop across the switch is unlimited, but the voltage at pins Y and Z may not exceed V_{CC} or GND.

Single-pole single-throw analog switch

10. Static characteristics

Table 7. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Max	Min	Max	
74HC1G	66-Q100							
V _{IH}	HIGH-level input	$V_{CC} = 2.0 V$	1.5	1.2	-	1.5	-	V
	voltage	$V_{CC} = 4.5 V$	3.15	2.4	-	3.15	-	V
		$V_{CC} = 6.0 V$	4.2	3.2	-	4.2	-	V
		$V_{CC} = 9.0 V$	6.3	4.7	-	6.3	-	V
VIL	LOW-level input	$V_{CC} = 2.0 V$	-	0.8	0.5	-	0.5	V
	voltage	$V_{CC} = 4.5 V$	-	2.1	1.35	-	1.35	V
		$V_{CC} = 6.0 V$	-	2.8	1.8	-	1.8	V
		$V_{CC} = 9.0 V$	-	4.3	2.7	-	2.7	V
I _I	input leakage current	E; $V_I = V_{CC}$ or GND						
		$V_{CC} = 6.0 V$	-	0.1	1.0	-	1.0	μA
		V _{CC} = 10.0 V	-	0.2	2.0	-	2.0	μA
$I_{S(OFF)}$	OFF-state leakage current	Y or Z; V_{CC} = 10 V; see Figure 4	-	0.1	1.0	-	1.0	μ A
I _{S(ON)}	ON-state leakage current	Y or Z; V_{CC} = 10 V; see <u>Figure 5</u>	-	0.1	1.0	-	1.0	μ A
I _{CC}	supply current	E, Y or Z; $V_I = V_{CC}$ or GND; $V_{SW} = GND$ or V_{CC}						
		$V_{CC} = 6.0 V$	-	1.0	10	-	20	μA
		V _{CC} = 10.0 V	-	2.0	20	-	40	μA
CI	input capacitance		-	1.5	-	-	-	рF
C _{S(ON)}	ON-state capacitance		-	8	-	-	-	pF

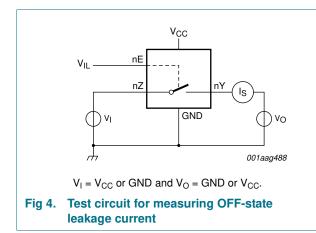
Single-pole single-throw analog switch

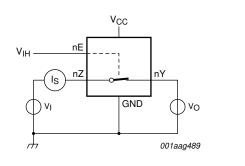
Voltages	are referenced to GN	D (ground = 0 V).						
Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ[1]	Max	Min	Max	
74HCT1	G66-Q100						1	
V _{IH}	HIGH-level input voltage	$V_{CC} = 4.5 V$ to 5.5 V	2.0	1.6	-	2.0	-	V
V _{IL}	LOW-level input voltage	$V_{CC} = 4.5 V$ to 5.5 V	0.1	1.2	0.8	-	0.8	V
lı	input leakage current	E; $V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	0.1	1.0	-	1.0	μA
$I_{S(OFF)}$	OFF-state leakage current	Y or Z; V_{CC} = 5.5 V; see <u>Figure 4</u>	-	0.1	1.0	-	1.0	μA
I _{S(ON)}	ON-state leakage current	Y or Z; V_{CC} = 5.5 V; see <u>Figure 5</u>	-	0.1	1.0	-	1.0	μA
I _{CC}	supply current	E, Y or Z; V ₁ = V _{CC} or GND; V _{SW} = GND or V _{CC} ; V _{CC} = 4.5 V to 5.5 V	-	1	10	-	20	μA
ΔI_{CC}	additional supply current	V_{I} = V_{CC} – 2.1 V; V_{CC} = 4.5 V to 5.5 V; I_{O} = 0 A	-	-	500	-	850	μA
CI	input capacitance		-	1.5	-	-	-	pF
$C_{S(ON)}$	ON-state capacitance		-	8	-	-	-	pF

 Table 7.
 Static characteristics ... continued

[1] Typical values are measured at $T_{amb} = 25 \text{ °C}$.

10.1 Test circuits





 $V_I = V_{CC}$ or GND and V_O = open circuit.

Fig 5. Test circuit for measuring ON-state leakage current

Single-pole single-throw analog switch

10.2 ON resistance

Table 8. ON resistance

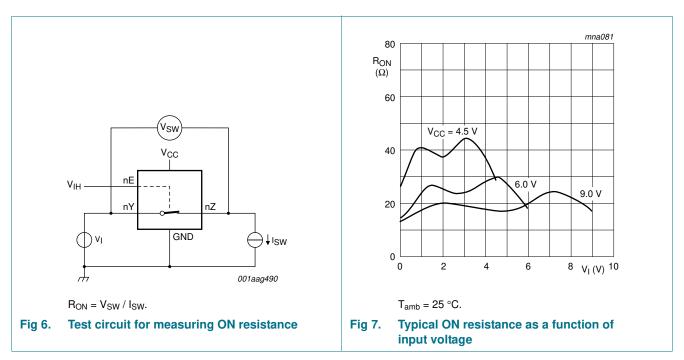
At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graph see Figure 7.

Symbol	Parameter	Conditions		°C to +8	5 °C	–40 °C t	o +125 °C	Unit
			Min	Typ <mark>[2]</mark>	Мах	Min	Max	
74HC1G6	6-Q100 <u>[1]</u>			1				
R _{ON(peak)}	ON resistance	$V_I = GND$ to V_{CC} ; see <u>Figure 6</u>						
	(peak)	$I_{SW} = 0.1 \text{ mA}; V_{CC} = 2.0 \text{ V}$	-	-	-	-	-	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	42	118	-	142	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	31	105	-	126	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 9.0 \text{ V}$	-	23	88	-	105	Ω
R _{ON(rail)}	ON resistance (rail)	V _I = GND; see <u>Figure 6</u>						
		$I_{SW} = 0.1 \text{ mA}; V_{CC} = 2.0 \text{ V}$	-	75	-	-	-	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	29	95	-	115	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	23	82	-	100	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 9.0 \text{ V}$	-	18	70	-	80	Ω
		$V_I = V_{CC}$; see <u>Figure 6</u>						
		$I_{SW} = 0.1 \text{ mA}; V_{CC} = 2.0 \text{ V}$	-	75	-	-	-	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	35	106	-	128	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	27	94	-	113	Ω
		$I_{SW} = 1 \text{ mA}; V_{CC} = 9.0 \text{ V}$	-	21	78	-	95	Ω
74HCT16	66-Q100							
R _{ON(peak)}	ON resistance	$V_I = GND$ to V_{CC} ; see Figure 6						
	(peak)	$I_{SW} = 1 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	42	118	-	142	Ω
R _{ON(rail)}	ON resistance (rail)	$V_I = GND$; see <u>Figure 6</u>						
		I_{SW} = 1 mA; V_{CC} = 4.5 V	-	29	95	-	115	Ω
		$V_I = V_{CC}$; see <u>Figure 6</u>						
		$I_{SW} = 1 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	35	106	-	128	Ω

[1] At supply voltages approaching 2 V, the ON resistance becomes extremely non-linear. Therefore it is recommended that these devices be used to transmit digital signals only, when using this supply voltage.

[2] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

Single-pole single-throw analog switch



10.3 ON resistance test circuit and graphs

11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$; $R_L = 1 \text{ k}\Omega$, unless otherwise specified; For test circuit, see Figure 10.

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C t	Unit	
				Min	Typ[1]	Max	Min	Max	
74HC1G	66-Q100								
t _{pd}	propagation delay	Y to Z or Z to Y; $R_L = \infty \Omega$; see Figure 8	[2]						
		$V_{CC} = 2.0 V$		-	8	75	-	90	ns
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
		$V_{CC} = 6.0 V$		-	2	13	-	15	ns
		V _{CC} = 9.0 V		-	1	10	-	12	ns
t _{en}	enable time	E to Y or Z; see Figure 9	[2]						
		$V_{CC} = 2.0 V$		-	50	125	-	150	ns
		$V_{CC} = 4.5 V$		-	16	25	-	30	ns
		$V_{CC} = 5.0 \text{ V}; C_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	13	21	-	26	ns
		$V_{CC} = 9.0 V$		-	9	16	-	20	ns

Single-pole single-throw analog switch

Table 9. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); $C_L = 50 \text{ pF}$; $R_L = 1 \text{ k}\Omega$, unless otherwise specified; For test circuit, see Figure 10.

Symbol	Parameter	Conditions		-40 °C to +85 °C Min Typ ^[1] Max		5 °C	–40 °C t	Unit	
			-			Min	Max		
t _{dis}	disable time	E to Y or Z; see Figure 9	[2]						
		$V_{\rm CC} = 2.0 \ V$		-	27	190	-	225	ns
		$V_{CC} = 4.5 V$		-	16	38	-	45	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	14	33	-	38	ns
		$V_{CC} = 9.0 V$		-	12	16	-	20	ns
C _{PD}	power dissipation capacitance	$V_{I} = GND \text{ to } V_{CC}$ [3]		-	9	-	-	-	pF
74HCT1	G66-Q100								
t _{pd}	propagation delay	Y to Z or Z to Y; $R_L = \infty \Omega$; see Figure 8	[2]						
		$V_{CC} = 4.5 V$		-	3	15	-	18	ns
t _{en}	enable time	E to Y or Z; see Figure 9	[2]						
		$V_{CC} = 4.5 V$		-	15	30	-	36	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
t _{dis}	disable time	E to Y or Z; see Figure 9	[2]						
		$V_{CC} = 4.5 V$		-	13	44	-	53	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
C _{PD}	power dissipation capacitance	$V_{I} = GND$ to $V_{CC} - 1.5$ V	<u>[3]</u>	-	9	-	-	-	pF

[1] All typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

t_{pd} is the same as t_{PLH} and t_{PHL}. t_{en} is the same as t_{PZL} and t_{PZH}.

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[3] C_{PD} is used to determine the dynamic power dissipation P_D (μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} + \Sigma ((C_{L} \times C_{SW}) \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = input frequency in MHz;$

 $f_o = output frequency in MHz;$

 C_L = output load capacitance in pF;

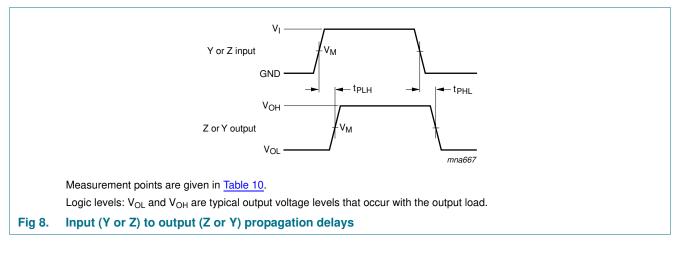
 C_{SW} = maximum switch capacitance in pF (see <u>Table 7</u>);

V_{CC} = supply voltage in Volt;

 $\Sigma ((C_L \times C_{SW}) \times V_{CC}^2 \times f_o) = sum of outputs.$

Single-pole single-throw analog switch

11.1 Waveforms and test circuit



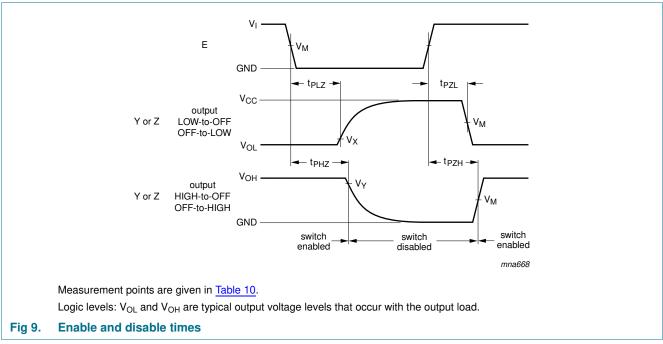


Table 10. Measurement points

Туре	Input	Output	Dutput				
	V _M	V _M	V _X	V _Y			
74HC1G66-Q100	0.5V _{CC}	0.5V _{CC}	V _{OL} + 10%	V _{OH} – 10%			
74HCT1G66-Q100	1.3 V	1.3 V	V _{OL} + 10%	V _{OH} – 10%			

NXP Semiconductors

74HC1G66-Q100; 74HCT1G66-Q100

Single-pole single-throw analog switch

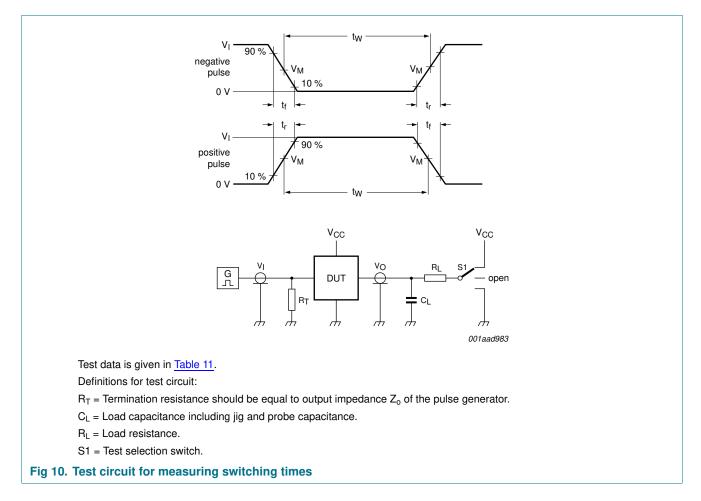


Table 11. Test data

Туре	Input		Load		S1 position		
	VI	t _r , t _f [1]	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
74HC1G66-Q100	GND to V _{CC}	6 ns	50 pF, 15 pF	1 kΩ, ∞ Ω	open	GND	V _{CC}
74HCT1G66-Q100	GND to 3 V	6 ns	50 pF, 15 pF	1 kΩ, ∞ Ω	open	GND	V _{CC}

[1] There is no constraint on t_r , t_f with a 50% duty factor when measuring f_{max} .

11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics for 74HC1G66-Q100 and 74HCT1G66-Q100

GND = 0 V; $t_r = t_f = 6.0$ ns; $C_L = 50$ pF; unless otherwise specified. All typical values are measured at $T_{amb} = 25$ °C.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
THD	total harmonic	$f_i = 1 \text{ kHz}; R_L = 10 \text{ k}\Omega; \text{see } \frac{\text{Figure } 11}{100000000000000000000000000000000$				%
	distortion	V _{CC} = 4.5 V; V _I = 4.0 V (p-p) -	-	0.04	-	%
	$\begin{split} V_{CC} &= 9.0 \text{ V}; \text{ V}_{I} = 8.0 \text{ V} \text{ (p-p)} \\ f_{i} &= 10 \text{ kHz}; \text{ R}_{L} = 10 \text{ k}\Omega; \text{ see } \underline{\text{Figure 11}} \\ V_{CC} &= 4.5 \text{ V}; \text{ V}_{I} = 4.0 \text{ V} \text{ (p-p)} \end{split}$	$V_{CC} = 9.0 \text{ V}; \text{ V}_{I} = 8.0 \text{ V} \text{ (p-p)}$	-	0.02	-	%
		$f_i = 10 \text{ kHz}; R_L = 10 \text{ k}\Omega; \text{see } \frac{\text{Figure 11}}{1000000000000000000000000000000000$				
		-	0.12	-	%	
		$V_{CC} = 9.0 \text{ V}; \text{ V}_{I} = 8.0 \text{ V} \text{ (p-p)}$	-	0.06	-	%

Single-pole single-throw analog switch

Table 12. Additional dynamic characteristics for 74HC1G66-Q100 and 74HCT1G66-Q100 ... *continued* GND = 0 V; $t_r = t_f = 6.0 \text{ ns}$; $C_L = 50 \text{ pF}$; unless otherwise specified. All typical values are measured at $T_{amb} = 25 \text{ °C}$.

SymbolParameterConditionsMinTypMaxUnit $f_{(-3dB)}$ -3 dB frequency
response $R_L = 50 \Omega; C_L = 10 \text{ pF}; \text{ see Figure 12} and 1313<math>V_{CC} = 4.5 \text{ V}$ -180-MHz

	response	$V_{CC} = 4.5 V$	-	180	-	MHz
		V _{CC} = 9.0 V	-	200	-	MHz
α_{iso}	isolation (OFF-state)	R_L = 600 $\Omega;f_i$ = 1 MHz; see Figure 14 and 15				
		$V_{CC} = 4.5 V$	-	-50	-	dB
		$V_{CC} = 9.0 V$	-	-50	-	dB

11.3 Test circuits and graphs

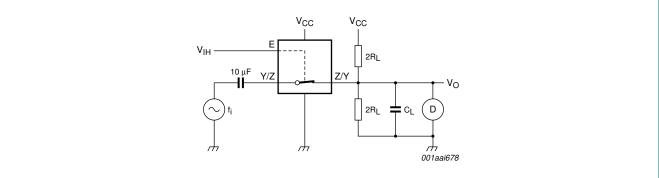
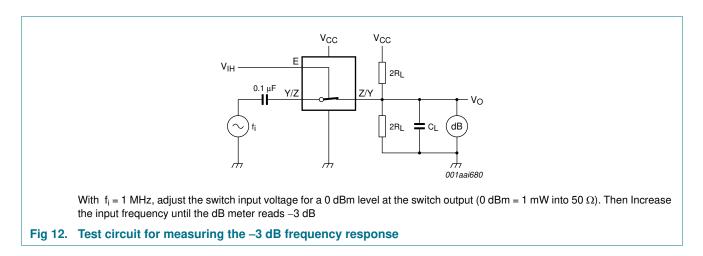


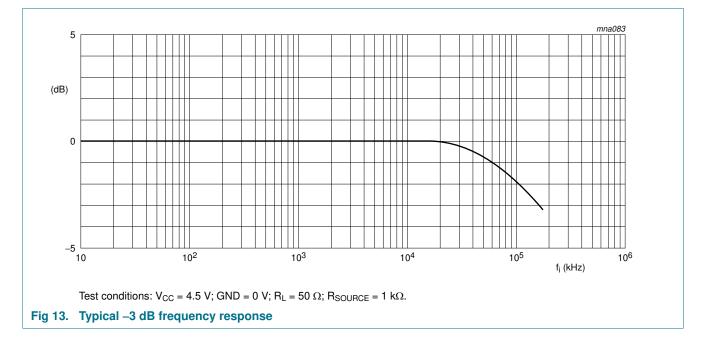
Fig 11. Test circuit for measuring total harmonic distortion

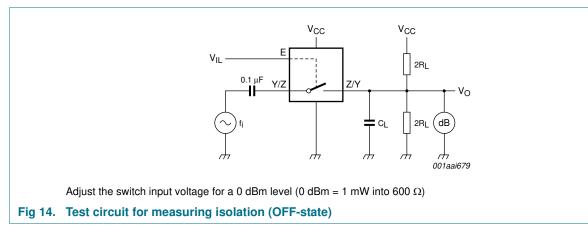


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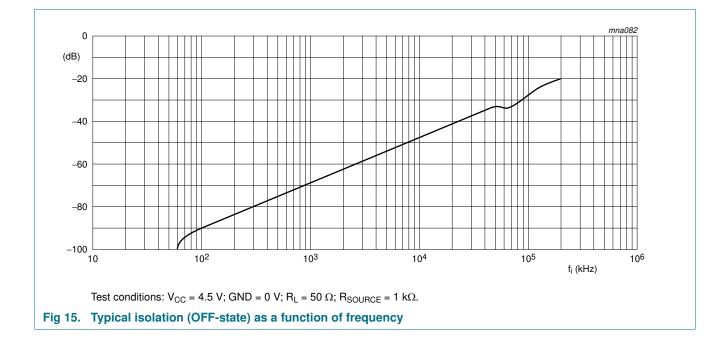




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12. Package outline

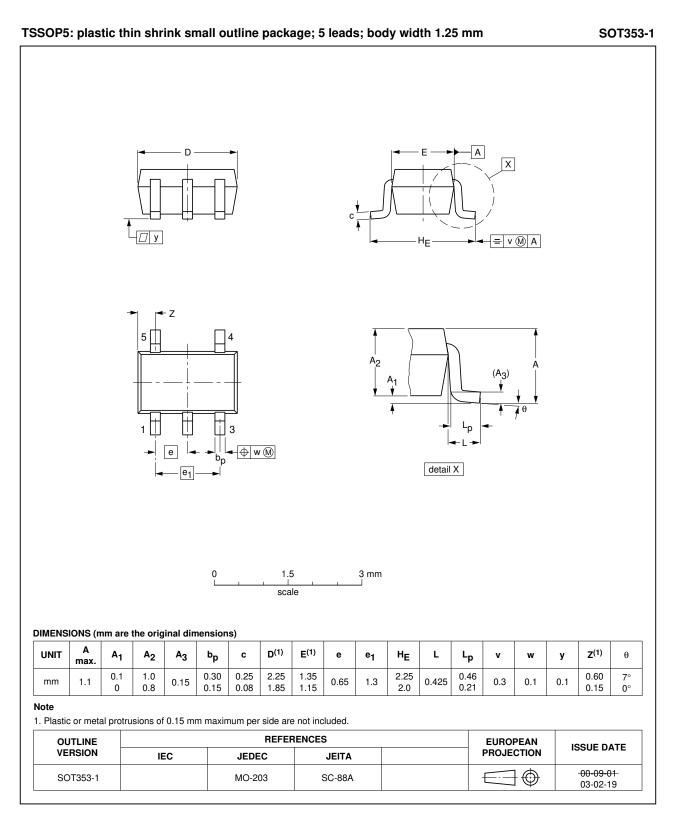


Fig 16. Package outline SOT353-1 (TSSOP5)

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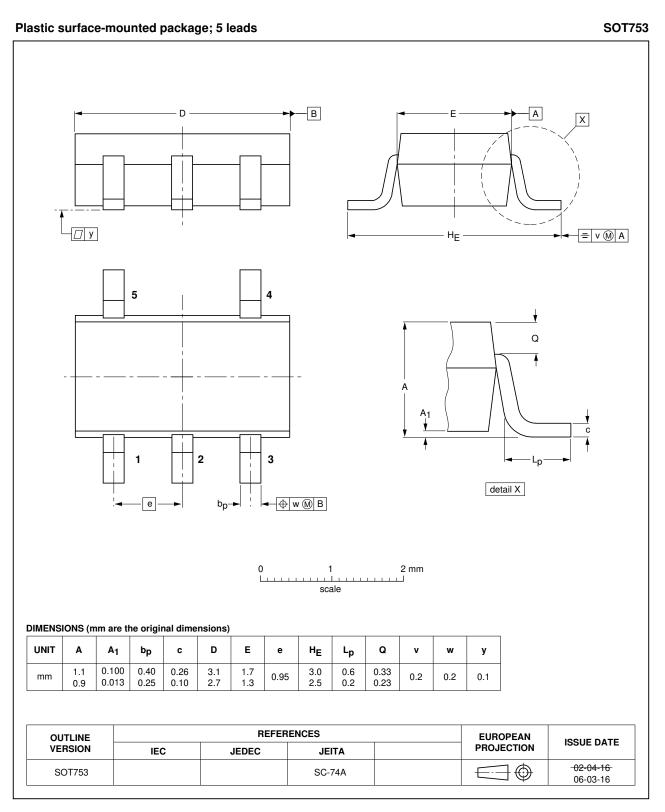


Fig 17. Package outline SOT753 (SC-74A)

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13. Abbreviations

Table 13.	Abbreviations
Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic
DUT	Device Under Test

14. Revision history

Table 14. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT1G66_Q100 v.1	20130916	Product data sheet	-	-

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15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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Single-pole single-throw analog switch

17. Contents

1	General description 1
2	Features and benefits 1
3	Ordering information 1
4	Marking 2
5	Functional diagram 2
6	Pinning information 2
6.1	Pinning 2
6.2	Pin description 2
7	Functional description 3
8	Limiting values 3
9	Recommended operating conditions 3
10	Static characteristics 4
10.1	Test circuits 5
10.2	ON resistance 6
10.3	ON resistance test circuit and graphs7
11	Dynamic characteristics 7
11.1	Waveforms and test circuit
11.2	Additional dynamic characteristics
11.3	Test circuits and graphs 11
12	Package outline 14
13	Abbreviations 16
14	Revision history 16
15	Legal information
15.1	Data sheet status 17
15.2	Definitions 17
15.3	Disclaimers
15.4	Trademarks
16	Contact information 18
17	Contents 19

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